

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Pang-Chun Lin	01/06/2010
Hsiao-Jen Hung	01/06/2010
Chun-Yuan Li	01/06/2010
Chien-Ping Huang	01/06/2010
Chun-Chi Ke	01/06/2010
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<b>Name:</b>	Siliconware Precision Industries Co., Ltd.
<b>Street Address:</b>	No. 123, Sec. 3, Da Fong Road, Tantzú
<b>City:</b>	Taichung
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12759237
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<b>ATTORNEY DOCKET NUMBER:</b>	85993(71987)
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Total Attachments: 1 source=85993_Assignment#page1.tif	

CH \$40.00 12759237

**501146409**

**PATENT**  
**REEL: 024224 FRAME: 0716**

CC-395 (26483US)

**ASSIGNMENT OF U.S. PATENT APPLICATION**

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s) (1) Pang-Chun LIN (2) Hsiao-Jen HUNG  
Full Name(s) (3) Chun-Yuan LI (4) Chien-Ping HUANG (5) Chun-Chi KE

Hereby sell, assign and transfer to

Assignee SILICONWARE PRECISION INDUSTRIES CO., LTD.  
Name and Address No. 123, Sec. 3, Da Fong Road, Tantz, Taichung, Taiwan (R.O.C.)

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled

Title of Invention: PACKAGE STRUCTURE FABRICATION METHOD

Which application was

Complete either a) executed by the undersigned on \_\_\_\_\_  
b) filed on the \_\_\_\_\_  
Serial No. \_\_\_\_\_

Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date Signed at TAIWAN, R.O.C.  
On January 6, 2010

Inventor(s)	<u>Pang-Chun Lin</u>	<u>Pang-Chun LIN</u>
Full Signature(s)	<u>Hsiao-Jen HUNG</u>	<u>Hsiao-Jen HUNG</u>
	<u>Chun-Yuan LI</u>	<u>Chun-Yuan LI</u>
	<u>Chien-Ping HUANG</u>	<u>Chien-Ping HUANG</u>
	<u>Chun-Chi KE</u>	<u>Chun-Chi KE</u>